

## SFP BI-DI 155Mbps TRANSCEIVER MODEL: SFP-BIDI-120DB



### Features:

- Fast Ethernet
- SDH/STM-1 155Mbps, SONET/OC-3
- SFP MSA package with Simplex LC/UPC connector
- Compliant with IEEE 802.3ah, ITU\_T G.985 class S standard
- Compliant with ITU -T G.957
- Digital diagnostic monitor interface compatible with SFF-8472
- Hot-pluggable SFP footprint
- Transmission with 9/125  $\mu$ m SMF
- Single 3.3V Power Supply and LVTTTL Logic
- Maximum Power at RX:  $\geq -5$  dBm
- Support Digital Diagnostic Monitoring - DDM
  - ◆ Temperature uncertainty  $\leq 3\%$
  - ◆ Supply Voltage uncertainty  $\leq 3\%$
  - ◆ TX, RX, sensitivity uncertainty  $\leq 3$  dB
- Compatibility with switches popular brands: Fujitsu, ALU, Huawei, Cisco, VFT, SWL2 ...
- Very low EMI and excellent ESD protection
- Operating Case Temperature:  $-10^{\circ}\text{C} \sim +70^{\circ}\text{C}$
- In conformity to safety code of FCC and CE MARK, ROHS compliant
- Class 1 laser safety certified
- Metal housing, rugged structure with good anti-magnetic ability

### Absolute Maximum Ratings

Table 1- Absolute Maximum Ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Supply Voltage	Vcc	-0.5	-	+3.6	V	
Storage Temperature	TS	-40	-	85	$^{\circ}\text{C}$	
Operating Relative Humidity	RH	+5	-	+95	%	

### Recommended Operating Conditions

**Table 2- Recommended operating Conditions**

Parameter	Symbol	Min.	Typ.	Max.	Units	Notes
Operating Case Temperature	TC	0	-	70	°C	
Power Supply Voltage	VCC	3.0	3.3	3.6	V	
Power Supply Current	ICC	-	-	300	mA	
Power Dissipation	PD	-	-	1	W	
Data Rate			155	-	Mbps	

### Electrical Characteristics

**Table 3- Electrical Characteristics**

Parameter	Symbol	Min.	Typ.	Max.	Units	Notes
Differential Data Input Swing	Vin p-p	200	-	2400	mV	1
Input Differential Impedance	RIN	80	100	120	Ω	
Tx_Disable	Laser Disable	VD	2.0	-	VCC+0.5	V
	Normal Operation	VEN	GND	-	GND+0.8	V
Tx_Fault	Transmitter Fault	VOH	2.0	-	VCC+0.5	V
	Normal Operation	VOL	GND	-	GND+0.8	V
Differential Data Output Swing	Vout p-p	1450	1600	1750	mV	2
Rx_LOS	Los Signal	VOH	2.0	-	VCC+0.5	V
	Normal Operation	VOL	GND	-	GND+0.8	V

Notes:

Internally AC coupled, input termination may be required for CML or LVPECL applications.  
Internally AC coupled, CML differential output stage.

### Optical Characteristics

**Table 4-Optical Characteristics**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Transmitter						
Average Output Power	P <sub>OUT</sub>	-15	-	-7	dBm	1
		-5	-	0		
Mean Wavelength	λ	1260	1310	1360	nm	
		1480	1490	1500		
		1540	1550	1600		
Extinction Ratio	ER	9	-	-	dB	
Spectral Width(RMS)	Δλ	-	-	1	nm	
P <sub>0</sub> ut@TX Disable Asserted	P <sub>0</sub> UT	-	-	-45	dB	
Rise/Fall Time (20%~80%)	Tr/Tf			260	ps	
Optical Eye Mask	IEEE 802.3ah Compliant					
Receiver						
Receiver Power (BER ≤ 10E-7)	Pin	-30	-		dBm	2
				-34		

Centre Wavelength	$\lambda$ C	1260	1310	1360	nm	
		1480	1490	1500		
		1530	1550	1600		
Receiver Overload	Rsens,high	-3	-	-	dBm	
Damage Threshold For Receive	Pin, damage	0				
Receiver Reflectance	RX_r	-	-	-12	dB	
LOS De-Assert	LOSD			-29	dB	5km
				-35		20km/40km/80km
LOS Assert	LOSA			-	dB	5km
				-45		20km/40km/80km
LOS Hysteresis		0.5		-	dB	

Note:  
Coupled into 9/125 SMF .  
Measured with PRBS 27-1 test pattern @155Mbps.BER=10E-12

**Recommended Interface Circuit**

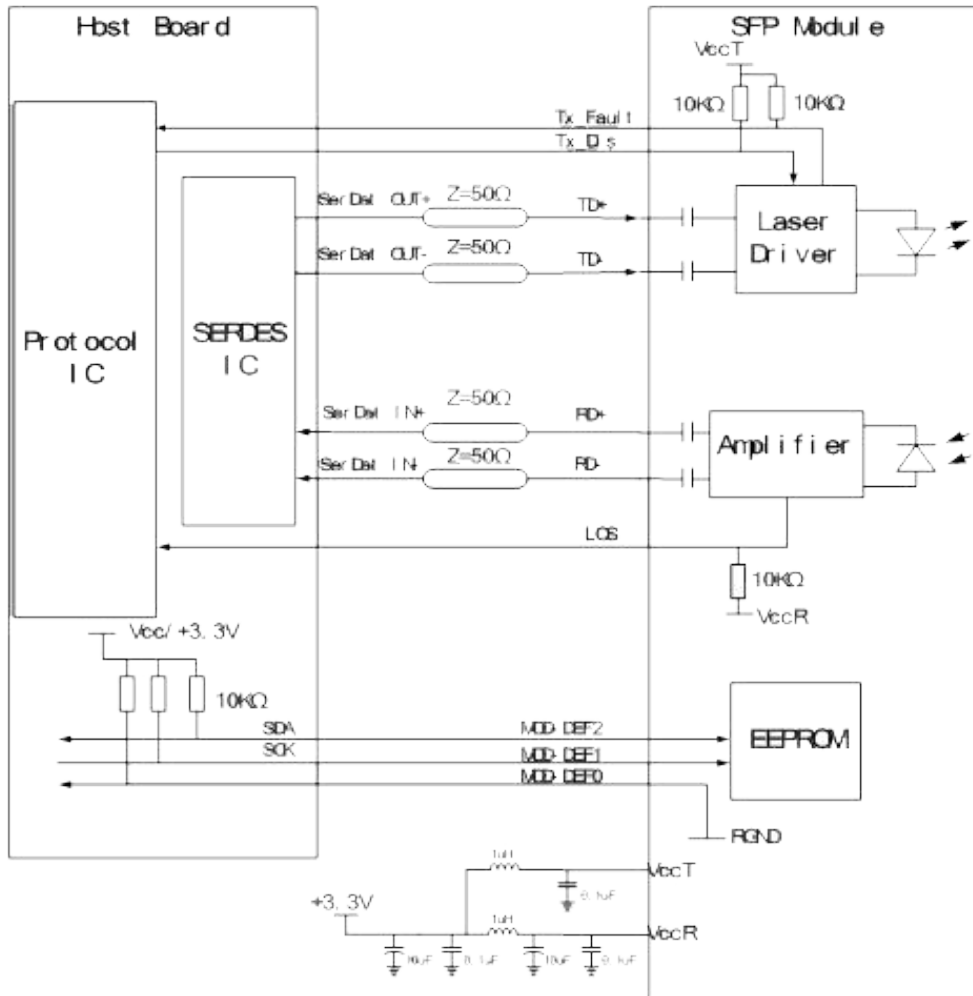


Figure 1, Recommended Interface Circuit

**Pin arrangement**

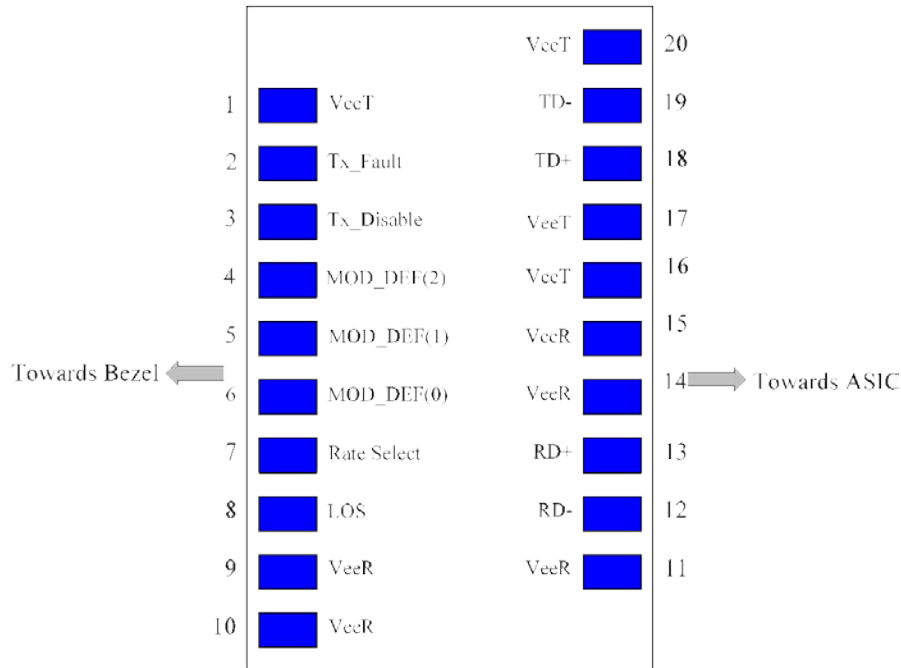


Figure 2, Pin View

**Table 5-Pin Function Definitions**

Pin	Name	FUNCTION	Plug Seq.	Notes
1	VeeT	Transmitter Ground	1	
2	TX Fault	Transmitter Fault Indication	3	1
3	TX Disable	Transmitter Disable	3	2
4	MOD-DEF2	Module Definition 2	3	3
5	MOD-DEF1	Module Definition 1	3	3
6	MOD-DEF0	Module Definition 0	3	3
7	Rate Select	Not Connect	3	
8	LOS	Loss of Signal	3	4
9	VeeR	Receiver Ground	1	5
10	VeeR	Receiver Ground	1	
11	VeeR	Receiver Ground	1	
12	RD-	Inv. Received Data Out	3	
13	RD+	Received Data Out	3	
14	VeeR	Receiver Ground	1	
15	VccR	Receiver Power	2	3.3V ± 5%,
16	VccT	Transmitter Power	2	3.3V ± 5%,
17	VeeT	Transmitter Ground	1	5
18	TD+	Transmit Data In	3	
19	TD-	Inv. Transmit Data In	3	
20	VeeT	Transmitter Ground	1	

Note:

1. TX Fault is open collector output which should be pulled up externally with a 4.7K ~10KΩ resistor on the host board to voltage between 2.0V and VCC+0.3V. Logic 0 indicates normal

- operation; logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- TX Disable input is used to shut down the laser output per the state table below. It is pulled up within the module with a 4.7~ 10K resistor.
 

Low (0- 0.8V):	Transmitter on
Between (0.8V and 2V):	Undefined
High (2.0 – VccT):	Transmitter Disabled
Open:	Transmitter Disabled
  - MOD-DEF 0, 1, 2. These are the module definition pins. They should be pulled up with a 4.7~10K resistor on the host board to supply less than VccT+0.3V or VccR+0.3V.
 

MOD-DEF 0 is grounded by the module to indicate that the module is present.

MOD-DEF 1 is clock line of two wire serial interface for optional serial ID.

MOD-DEF 2 is data line of two wire serial interface for optional serial ID.
  - LOS (Loss of signal) is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates loss of signal. In the low state, the output will be pulled to less than 0.8V.

**Table 6- Stability**

Operating in special condition environment	Cold temperature. Profile test: - Temperature: -5 <sup>0</sup> C - Duration: 16h (Reference: ETSI EN 300 019-2-3 T 3.2, IEC 60068-2-1)
	High temperature. Profile test: - Temperature: +55 <sup>0</sup> C - Duration: 16h (Reference: ETSI EN 300 019-2-3 T 3.3, IEC 60068-2-2)
	High relative humidity (Damp heat, steady state). Profile test: - Temperature: +3 <sup>0</sup> □C, - Relative humidity: 93%RH - Duration: 4 days. (Reference: ETSI EN 300 019-2-3 T 3.3, IEC 60068-2-56)
Working environment	Operating temperature: 0÷40°C Operating humidity: 10÷90% non-condensing (The bidder has to provide test report confirm about environment)

**Digital Diagnostic Memory Map**

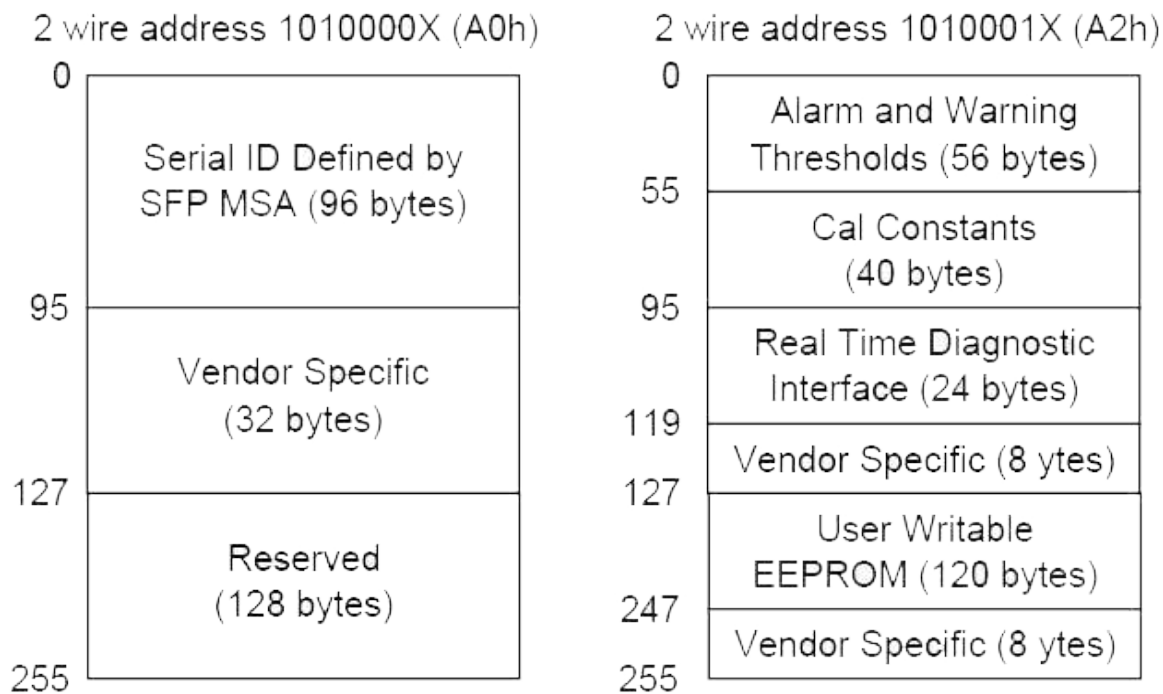


Figure 3, memory map

Mechanical Diagram

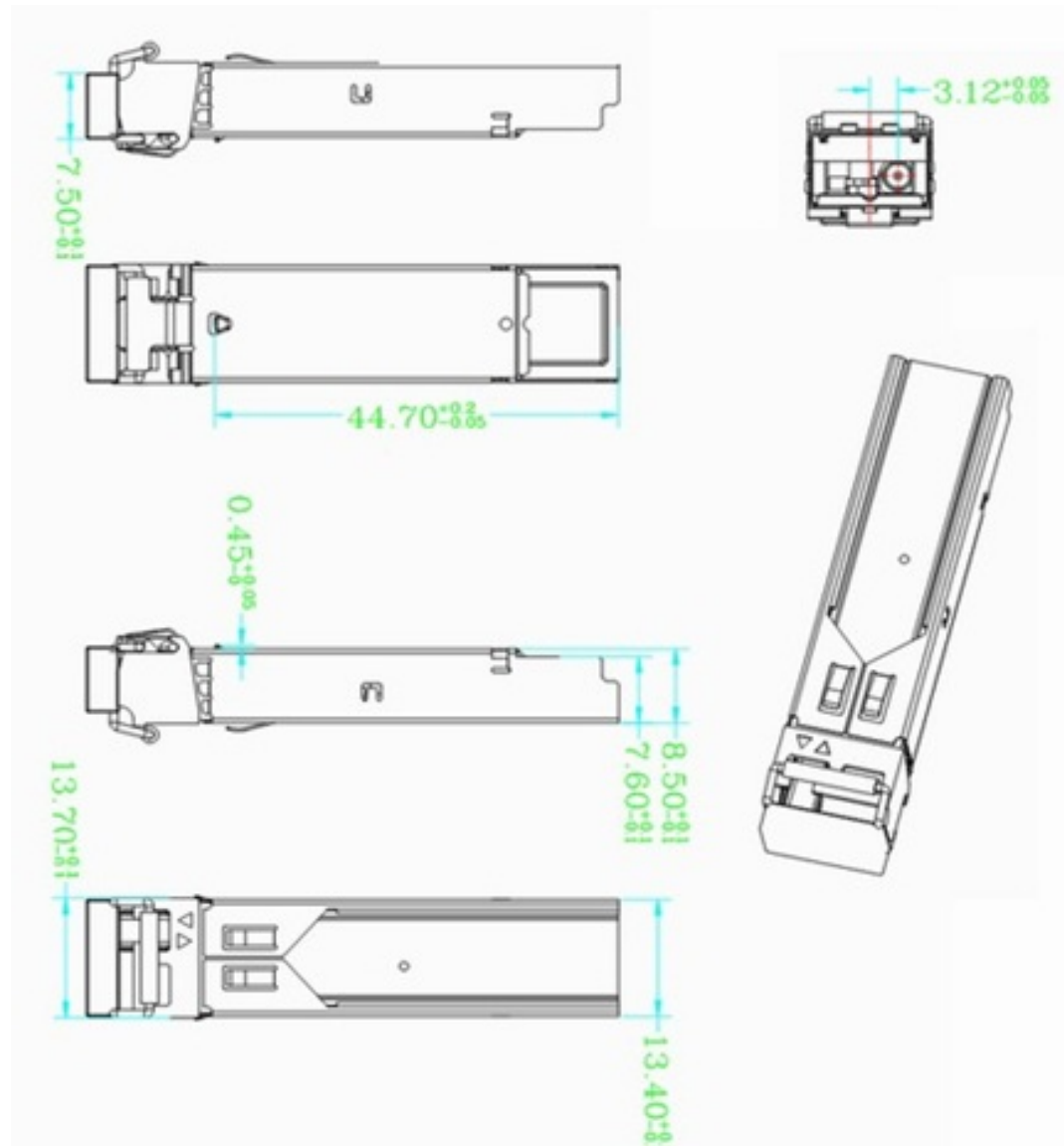


Figure 4, mechanical diagram

### Ordering information

Part No.	Data Rate	Wavelength (nm)	Reach	TX	RX	Temperature
SFP-BIDI-120DA	155M	1310/1550	20KM	VCSEL	PIN	-10~70°C
SFP-BIDI-120DB	155M	1550/1310	20M	VCSEL	PIN	-10~70°C
SFP-BIDI-140DA	155M	1310/1550	40KM	FP	PIN	-10~70°C
SFP-BIDI-140DB	155M	1550/1310	40KM	FP	PIN	-10~70°C
SFP-BIDI-160DA	155M	1490/1550	60KM	FP	PIN	-10~70°C
SFP-BIDI-160DB	155M	1550/1490	60KM	FP	PIN	-10~70°C
SFP-BIDI-180DA	155M	1490/1550	80KM	DFB	PIN	-10~70°C
SFP-BIDI-180DB	155M	1550/1490	80KM	DFB	PIN	-10~70°C

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